



### Features

- Single fiber bi-directional data links with asymmetric 2.48832 Gbps upstream and 9.95328 Gbps downstream
- Sleep Mode for Power Consumption
- 1270nm burst mode transmitter with DFB Laser
- 1577nm continuous mode receiver with APD
- Compliant with ITU-TG.987.2 XG-GPON N2 class
- SFP+ MSA SFF-8431 Compliant
- Digital diagnostic SFF-8472 Rev9.5 Compliant
- Telcordia GR-468 compliant
- Single 3.3V power supply
- Operation case temperature: -5-70°C
- SFP+ (Small Form-factor Pluggable Plus) package with SC receptacle optical interface.
- RoHS Compliant

### Regulatory Compliance

**Table 1 - Regulatory Compliance**

Feature	Standard	Performance
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883E Method 3015.7	Class 1(>500 V)
Electrostatic Discharge (ESD) to the Duplex LC Receptacle	IEC 61000-4-2	Compatible with standards
Electromagnetic Interference (EMI)	FCC Part 15 Class B EN55022 Class B (CISPR 22B)	Compatible with standards
Immunity	IEC 61000-4-3	Compatible with standards
Laser Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN60950, EN (IEC) 60825-1,2	Compatible with Class I laser product.
Component Recognition	UL and CSA	Compliant with standards
RoHS	2002/95/EC 4.1&4.2 2005/747/EC	Compliant with standards <sup>note</sup>

**Note:**

In light of item 5 in Annex of 2002/95/EC, "Pb in the glass of cathode ray tubes, electronic components and fluorescent tubes." and item 13 in Annex of 2005/747/EC, "Lead and cadmium in optical and filter glass.", the two exemptions are being concerned for Source Photonics transceivers, because Source Photonics transceivers use glass, which may contain Pb, for components such as lenses, windows, isolators, and other electronic components.

## Absolute Maximum Ratings

**Table 2 - Absolute Maximum Ratings**

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Storage Ambient Temperature	T <sub>S</sub>	-40	-	85	°C	
Operating Case Temperature	T <sub>C</sub>	-5		70	°C	1
Operating Relative Humidity	RH	5		95	%	
Power Supply Voltage	V <sub>CC</sub>	0		4	V	

Note 1: When ambient temperature is above 60°C, airflow at rate higher than 1m/sec is required.

## Recommended Operating Conditions

**Table 3 – Recommended Operating Conditions**

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Power Supply Voltage	V <sub>CC</sub>	3.13	3.3	3.47	V	
Operating Case Temperature	T <sub>C</sub>	-5		70	°C	1
Operating Relative Humidity	RH	5		95	%	
Data Rate	DR		2.48832		Gbit/s	2
Data Rate Drift		-100		+100	PPM	

Note 1: When ambient temperature is above 60°C, airflow at rate higher than 1m/sec is required.

2: PRBS2<sup>23</sup>-1.

## Optical Characteristics

**Table 4 – Optical Characteristics**

Transmitter						
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Centre Wavelength	λ <sub>C</sub>	1260		1280	nm	
Spectral Width (-20dB)	Δλ			1	nm	
Side Mode Suppression Ratio	SMSR	30			dB	
Average Launch Power	P <sub>OUT</sub>	2		7	dBm	1
Average Launch Power-OFF	P <sub>OFF</sub>			-43.5	dBm	
Extinction Ratio	EX	8.2			dB	2
Total Jitter	TJ			0.2	UI	2
Rise/Fall Time (20%-80%)	T <sub>R</sub> /T <sub>F</sub>			140	ps	2,3
Burst Turn On Time	T <sub>BURST_ON</sub>			32	ns	4
Burst Turn Off Time	T <sub>BURST_OFF</sub>			32	ns	4
Optical Return Loss Tolerance		-15			dB	

Transmitter Reflectance				-6	dB	
Optical Eye Mask	Compliant With ITU-T G.987.2					
<b>Receiver</b>						
Operating Wavelength	$\lambda_C$	1575	1577	1580	nm	
Sensitivity	$P_{SEN1}$			-24	dBm	5
	$P_{SEN2}$			-28		
Saturation	$P_{SAT}$	-8			dBm	
Receiver Total Jitter	TJ	-	-	0.7	UI	
Receiver Deterministic Jitter	DJ	-	-	0.42	UI	
Loss of Signal Deassert Level	$P_{LOSD}$			-29	dBm	
Loss of Signal Assert Level	$P_{LOSA}$	-40	-		dBm	
LOS Hysteresis	$P_{LOSD} - P_{LOSA}$	0.5		6	dB	
Receiver Reflectance <sup>(6)</sup>				-20	dB	
WDM Filter Isolation	ISO(1550)	38			dB	1550nm
	ISO(1650)	35			dB	1650nm

**Notes:**

- The optical power is launched into 9/125um SMF.
- Measured with PRBS 2<sup>23</sup>-1 test pattern @2.48832Gbps.
- Measured with the Bessel-Thompson filter OFF.
- Refer to [Timing Parameter Definition in Burst Mode Sequence](#)
- $P_{SEN1}$  measured with a PRBS2<sup>23</sup>-1 test pattern@9.95328Gbps, BER  $\leq 10^{-10}$  for reference  
 $P_{SEN2}$  measured with a PRBS2<sup>23</sup>-1 test pattern @9.95328Gbps, BER  $\leq 10^{-3}$
- From external 1260-1280nm to 1575-1580nm
- From internal 1260-1280nm to 1575-1580nm

## Electrical Characteristics

**Table 5 – Electrical Characteristics**

<b>Transmitter</b>						
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Power Supply Current	$I_{CC\_TX}$			250	mA	
Data Input Differential Swing	$V_{IN}$	200		1600	mVp-p	1
Input Differential Impedance	$Z_{IN}$	90	100	110	$\Omega$	
Transmitter Disable Voltage - Low	$V_{TDIS\_L}$	0		0.8	V	2
Transmitter Disable Voltage - High	$V_{TDIS\_H}$	2.0		Vcc	V	
Transmitter Fault Assert Time	T-FAULT-ON	0		0.4	V	
Transmitter Fault Reset	TX_Fault Reset	2.4		Vcc	V	
Power Down Voltage _Low	$V_{\_PDL}$	0		0.8		

Power Down Voltage _High	$V_{\_PDH}$	2.0		$V_{CC}$		
TX Power Down Assert Time	$T_{\_PD \text{ assert}}$			512	ns	
Recovery Time following TX Power Down	$T_{\_PD \text{ recover}}$			512	ns	
Receiver						
Power Supply Current	$I_{CC\_RX}$			200	mA	
Data Output Differential Swing	$V_{OUT}$	600		900	mV <sub>P-P</sub>	3
Loss of Signal (LOS) Voltage - Low	$V_{LOS,L}$	0		0.8	V	
Loss of Signal (LOS) Voltage - High	$V_{LOS,H}$	2.4		$V_{CC}$	V	
Loss of Signal (LOS) Assert Time	$T_{ASS}$			100	μs	
Loss of Signal (LOS) Deassert Time	$T_{DAS}$			100	μs	
Output Differential Impedance	$R_{out}$	80	100	120		
Time to Initialize 2-Wire Interface				300	ms	
Time to Initialize				300	ms	

Notes:

- Compatible with LVPECL/CML input, AC coupled internally. (See [Recommended Interface Circuit](#))
- TX\_nBRST (See [Pin Function Definitions](#)).
- CML output, AC coupled internally, guaranteed in the full arrange of input optical power (-9dBm to -24dBm)

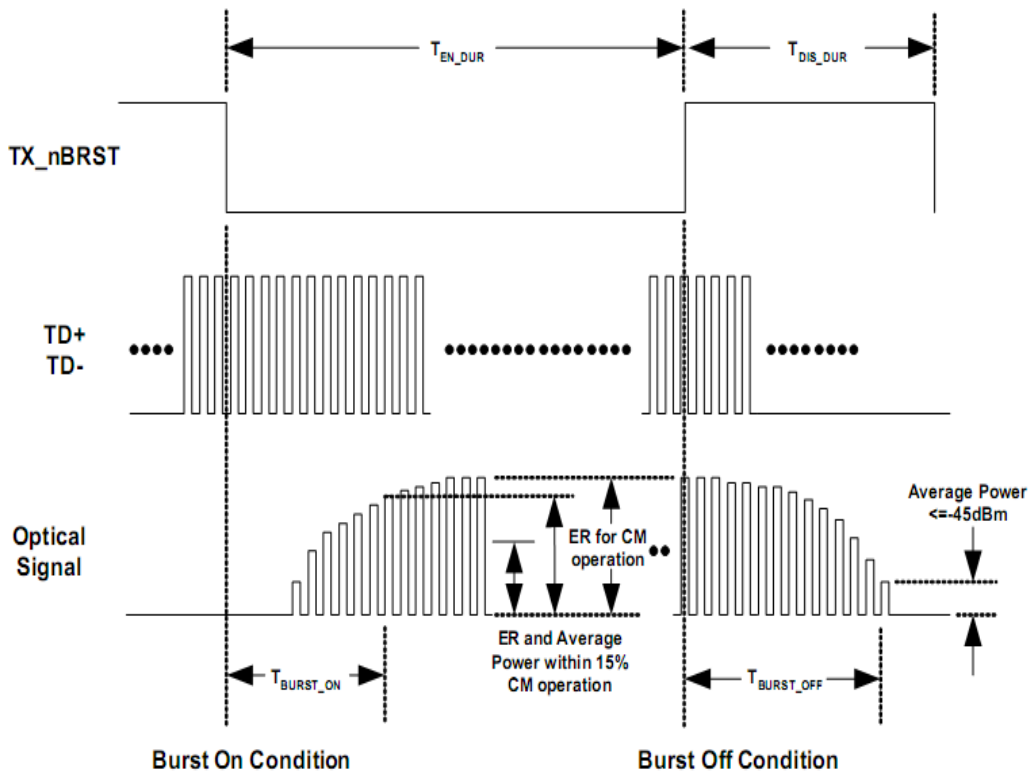


Figure 1, Timing Parameter Definition in Burst Mode Sequence

## Diagnostics

Table 6 – Diagnostics

Parameter	Range	Accuracy	Unit	Calibration
Temperature	-5 to 70	±3	°C	Internal
Voltage	0 to Vcc	±3%	V	Internal
Bias Current	0 to 90(notes)	±10%	mA	Internal
Tx Power	2 to 7	±3	dB	Internal
Rx Power	-30 to -8	±2	dB	Internal

Notes: only for continuous mode

**Table 7 – EEPROM Serial ID (A0h)**

Addr.	Field Size (Bytes)	Name of Field	Hex	Description
0	1	Identifier	03	SFP+ transceiver
1	1	Ext. Identifier	04	MOD4
2	1	Connector	01	SC
3-10	8	Transceiver	00 10 00 00 00 00 00 00	OC48
11	1	Encoding	03	NRZ
12	1	BR, Nominal	19	2.48832Gbps
13	1	Reserved	00	
14	1	Length (9um)-km	14	20(km)
15	1	Length (9um)	C8	200(100m)
16	1	Length (50um)	00	Not Support MMF
17	1	Length (62.5um)	00	Not Support MMF
18	1	Length (Copper)	00	Not Support Copper
19	1	Reserved	00	
20-35	16	Vendor name	53 4F 55 52 43 45 50 48 4F 54 4F 4E 49 43 53 20	“SOURCEPHOTONICS”(ASC II)
36	1	Reserved	00	
37-39	3	Vendor OUI	00 1F 22	SP vendor OUI
40-55	16	Vendor PN	53 50 50 53 32 37 34 38 46 4E 32 43 44 46 41 20	“SPPS2748FN2CDFA (ASCII)
56-59	4	Vendor Rev	X X 20 20	ASCII(“31 30 20 20” means 1.0 Revision)
60-61	2	Wavelength	04 F6	1270nm Laser Wavelength
62	1	Reserved	00	
63	1	CC_BASE	xx	Check sum of byte 0-62
64-65	2	Options	00 0A	LOS,TX_FAULT
66	1	BR, max	00	
67	1	BR, min	00	
68-83	16	Vendor SN	xx xx xx xx xx xx xx xx xx xx xx xx xx xx xx xx	ASCII
84-91	8	Date code	xx xx xx xx xx xx 20 20	Year(2bytes),Month(2bytes),

				Day(2 bytes)
92	1	Diagnostic Monitoring Type	68	Compliant with SFF-8472 V9.5 Externally Calibrated Received power measurement type -Average Power
93	1	Enhanced Options	F0	Diagnostics (Optional Alarm/warning flags) Soft TX_FAULT monitoring implemented Soft TX_Disable monitoring implemented Soft RX_LOS monitoring implemented
94	1	SFF-8472 Compliance	02	Diagnostics Compliance(SFF-8472 V9.5)
95	1	CC_EXT		Check sum of byte 64-94
96-255	64	Vendor Specific		

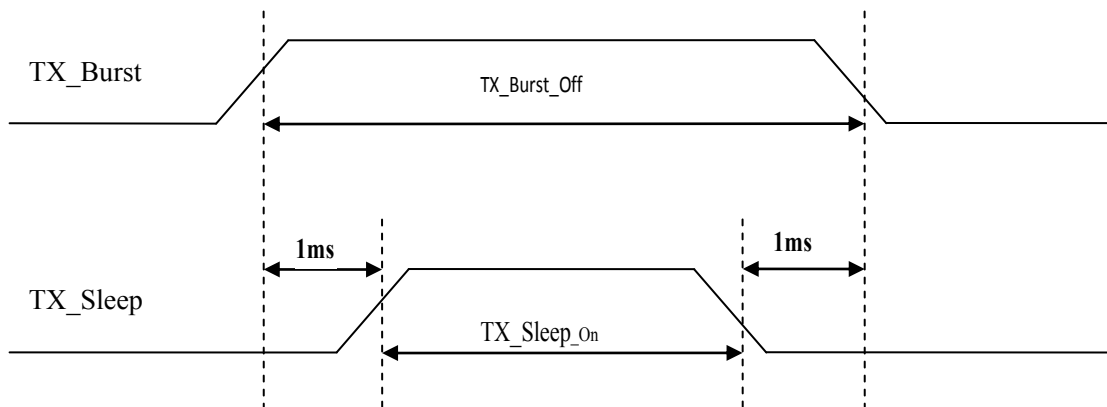
**Table 8– Pin Definitions**

Pin	Symbol	Name/Description
1	VeeT	Module Transmitter Ground (note1)
2	TX_FAULT	Module Transmitter Fault
3	TX_nBRST	Transmitter Burst Control (note2)
4	SDL	2-Wire Serial Interface Data Line (MOD-DEF2) (note3)
5	SCL	2-Wire Serial Interface Clock (MOD-DEF1)
6	MOD_ABS	Module Absent, connected to VeeT or VeeR in the module
7	Tx_SD	Tx Signal Detect (note4)
8	RX_LOS	Receiver Loss of Signal Indication (in FC designated as RX_LOS, in SONET designated as LOS, and in Ethernet designated as NOT Signal Detect)
9	PDWN_TX	Power saving of Tx side, On/off time less than 1ms, high active, if not use this feature, main board connection should be NC.(Note5)
10	VeeR	Module Receiver Ground
11	VeeR	Module Receiver Ground
12	RXD-	Receiver Inverted Data Output
13	RXD+	Receiver Non-Inverted Data Output
14	VeeR	Module Receiver Ground
15	VCCR	Module Receiver 3.3V Supply
16	VCCT	Module Transmitter 3.3V Supply
17	VeeT	Module Transmitter Ground
18	TXD+	Transmitter Non-Inverted Data Input
19	TXD-	Transmitter Inverted Data Input

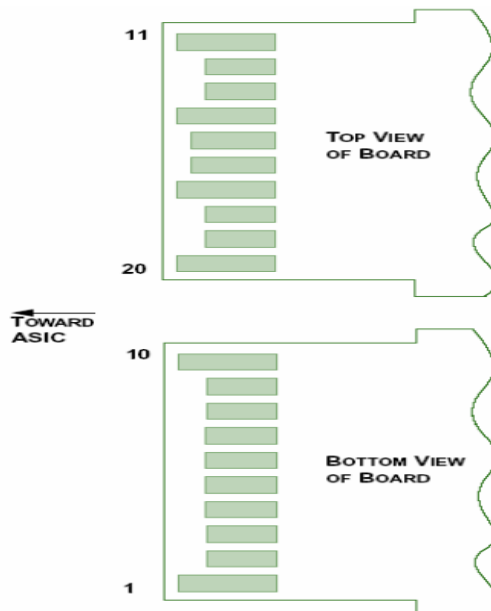
20	VeeT	Module Transmitter Ground
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Note

1. The module ground pins, VeeR and VeeT, shall be isolated from the module case.
2. Tx\_nburst is an input that is used to shut down the transmitter optical output.
3. MOD-DEF0,1,2. These are the module definition pins. They should be pulled up with a 4.7K-10KΩ resistor on the host board. The pull-up voltage shall be  $V_{ccT}$  or  $V_{ccR}$ .
4. Tx Signal Detect, Tx Active State: High.
5. Tx Power saving function timing: Tx\_Sleep

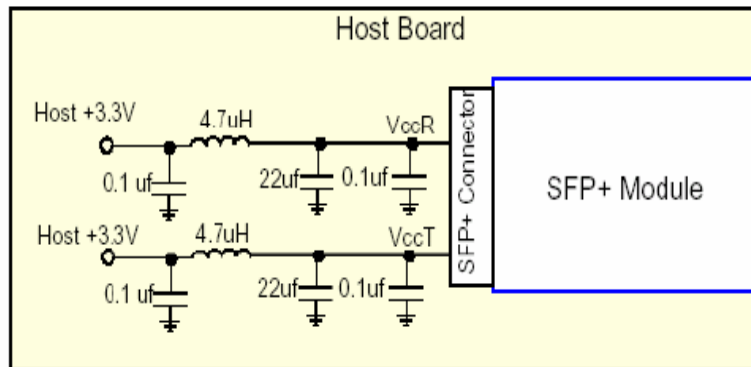


SFP+ Module PCB Pinout

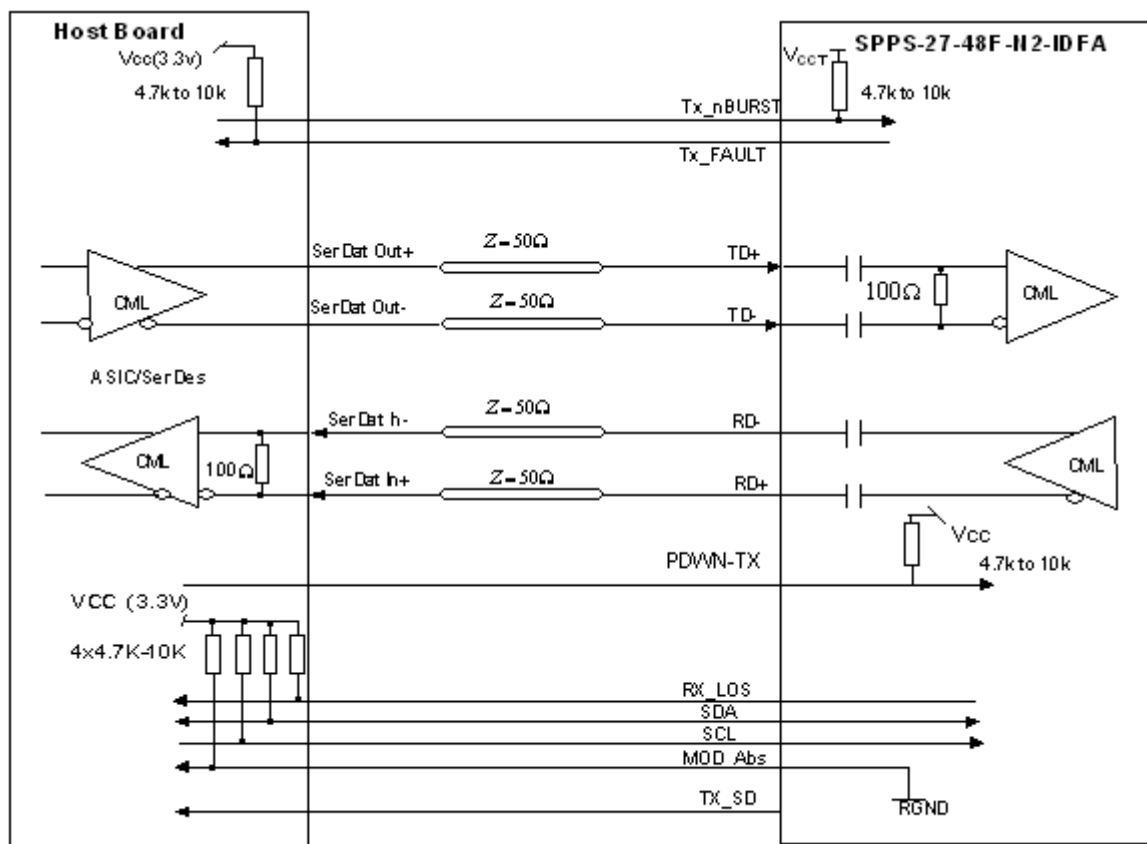


Recommended Host Board Power Supply Circuit





**Recommended Interface Circuit**



**Figure 2, Recommended Interface Circuit**

**Mechanical Diagram**



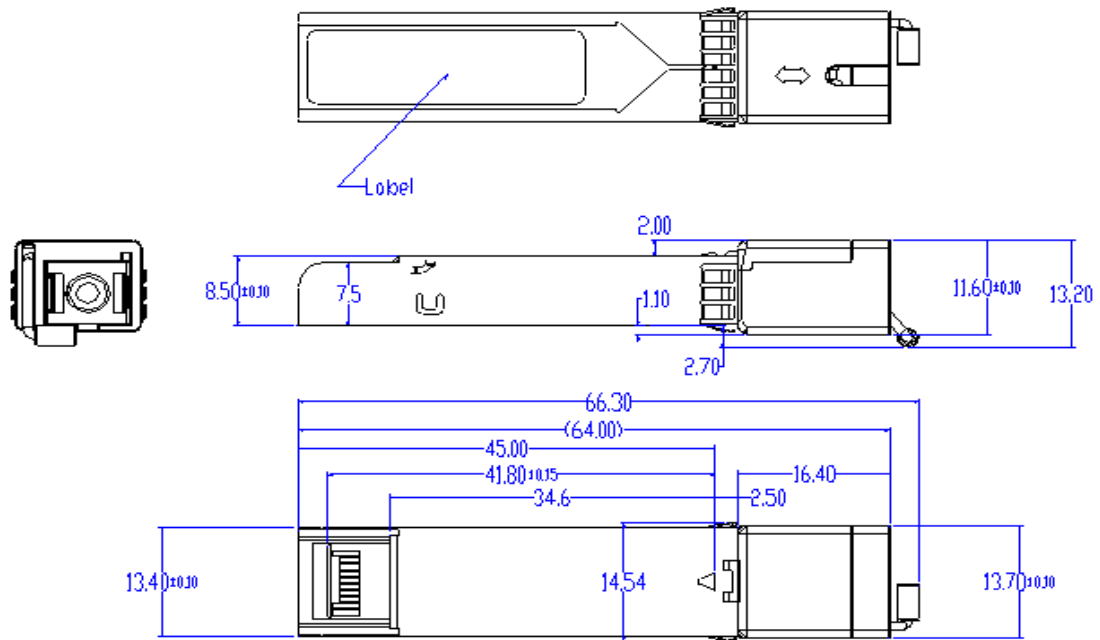


Figure 3, Mechanical Diagram

### Order Information

Table9 – Order Information

Part No.	Application	Data Rate	Laser Source	Fiber Type
SPPS-27-48F-N2-CDFA	XGPON N1/N2 Class ONT	Tx 2.48832Gb/s and Rx 9.95328Gb/s asymmetric	1270nm DFB	SMF

## Warnings

**Handling Precautions:** This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.

**Laser Safety:** Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.

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